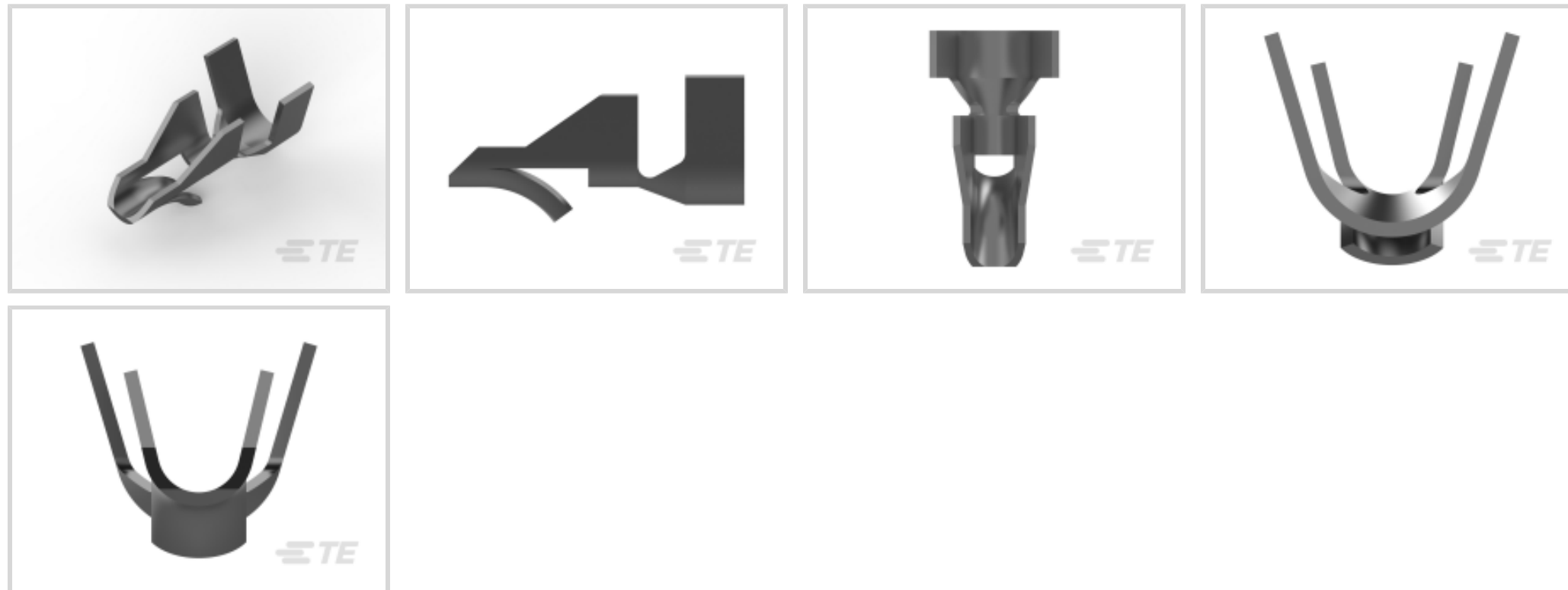




Terminals & Splices > PCB Terminals



PCB Terminal Type: PCB Pin

PCB Thickness (Recommended): 1.57 mm [.062 in]

PCB Hole Diameter: 1.83 mm [.072 in]

Accepts Wire Insulation Diameter (Max): 2.79 mm [.11 in]

Accepts Wire Insulation Diameter Range: 1.52 – 2.79 mm [.06 – .11 in]

Features

Product Type Features

PCB Terminal Mounting Style	Stud Mount
Wire Insulation Support Retention Type	Insulation Support

Configuration Features

Stud Hole	No
Terminal Angle	180 °

Body Features

Finish	Bright
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Contact Features

Contact Plating Material	Tin
PCB Terminal Type	PCB Pin
Terminal Size	Miniature
Terminal Orientation	Straight

Termination Features

Termination Method to Wire & Cable	Crimp
Product Terminates To	Printed Circuit Board

Mechanical Attachment

Wire Insulation Support	With
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Dimensions

Extension Below Board	3.43 mm[.135 in]
PCB Thickness (Recommended)	1.57 mm[.062 in]
PCB Hole Diameter	1.83 mm[.072 in]
Accepts Wire Insulation Diameter (Max)	2.79 mm[.11 in]
Accepts Wire Insulation Diameter Range	1.52 – 2.79 mm[.06 – .11 in]
Wire Size	.3 – .9 mm ²

Usage Conditions

Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]
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Packaging Features

Packaging Quantity	10000
Packaging Method	Reel

Product Compliance

[For compliance documentation, visit the product page on TE.com>](#)

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JAN 2022 (223) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not applicable for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits

as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Documents

Product Drawings

MINI AMP-IN 22-18 PTLP/PHBZ

English

CAD Files

3D PDF

3D

Customer View Model

[ENG_CVM_CVM_350566-1_AU.2d_dxf.zip](#)

English

Customer View Model

[ENG_CVM_CVM_350566-1_AU.3d_igs.zip](#)

English

Customer View Model

[ENG_CVM_CVM_350566-1_AU.3d_stp.zip](#)

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

Product Specifications

Application Specification

English

Product Environmental Compliance

TE Material Declaration

English